

B200021



▶ 主要技术特性 (Main Specifications)

- ▶ 适用导线规格 (Applicable wire) : --
- ▶ 适用基板厚度 (Applicable PC board thickness) : 0.8mm~1.6mm
- ▶ 温度范围 (Temperature range) : -25°C~+85°C
- ▶ 额定电压 (Voltage rating) : 250V AC, DC
- ▶ 额定电流 (Current rating) : 2A AC, DC
- ▶ 接触电阻 (Contact resistance) : $\leq 0.02\Omega$
- ▶ 绝缘电阻 (Insulation resistance) : $\geq 1000M\Omega$
- ▶ 耐压 (Withstanding voltage) : 800V AC/minute

材料及电镀规格 Material and Finish

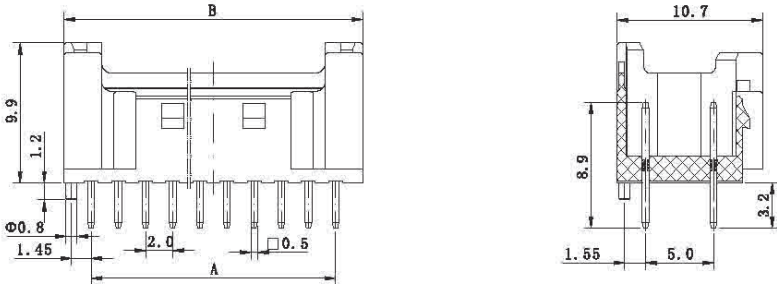
型号 Type	材料 Material	材料厚度 Material Thickness	电镀规格 Finish
插座 WAFER	塑胶 HOUSING	PA66 UL94V-0	N/A
	针 PIN	黄铜 Brass	镀锡 Tin-plated

产品尺寸图 Product size chart

 单位: mm 一般公差: ± 0.20

WAFER

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极数 Circuits	型号 Type	尺寸 (Dimensions) mm		备注型号 P. S. Type
		A	B	
10	B200021-1-10	8.0	12.0	
12	B200021-1-12	10.0	14.0	
14	B200021-1-14	12.0	16.0	
16	B200021-1-16	14.0	18.0	
18	B200021-1-18	16.0	20.0	
20	B200021-1-20	18.0	22.0	